

LM4882 Boomer® Audio Power Amplifier Series 250mW Audio Power Amplifier with Shutdown Mode

General Description

The LM4882 is a single-ended audio power amplifier capable of delivering 250 mW of continuous average power into an 8Ω load with 1% (THD + N) from a 5V power supply. Boomer® audio power amplifiers were designed specifically to provide high quality output power with a minimal amount of external components using surface mount packaging. Since the LM4882 does not require bootstrap capacitors or snubber networks, it is optimally suited for low-power portable systems.

The LM4882 features an externally controlled, low power consumption shutdown mode which is virtually clickless and popless, as well as an internal thermal shutdown protection mechanism.

The unity-gain stable LM4882 can be configured by external gain-setting resistors.

Key Specifications

- THD + N at 1 kHz at 250 mW continuous average output power into 8Ω
- 1.0% (max)
- Output Power at 1% THD + N at 1kHz into 4Ω
- 380mW (typ)
- THD + N at 1 kHz at 85 mW continuous average output power into 32Ω
- 0.1% (typ)

- Shutdown Current
- 0.7 µA (typ)

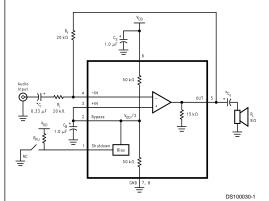
Features

- MSOP surface mount packaging
- "Click and Pop" Suppression Circuitry
- Supply voltages from 2.4V-5.5V
- Operating Temperature -40°C to 85°C
- Unity-gain stable
- External gain configuration capability
- No bootstrap capacitors, or snubber circuits are necessary

Applications

- Personal Computers
- Cellular Phones
- General Purpose Audio

Typical Application

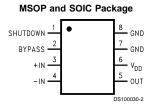


*Refer to the Application Information Section for information concerning proper selection of the input and output coupling capacitors.

FIGURE 1. Typical Audio Amplifier Application Circuit

Boomer® is a registered trademark of National Semiconductor Corporation

Connection Diagram



Top View Order Number LM4882MM or LM4882M See NS Package Number MUA08A or M08A

© 1998 National Semiconductor Corporation DS100030

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage 6.0 VStorage Temperature $-65^{\circ}\text{C to} + 150^{\circ}\text{C}$ Input Voltage $-0.3\text{V to V}_{DD} + 0.3\text{V}$ Power Dissipation (Note 3) Internally limited ESD Susceptibility (Note 4) 2000VPln 5 1500V

Junction Temperature 150°C
Soldering Information
Small Outline Package

Vapor Phase (60 seconds) 215°C Infrared (15 seconds) 220°C See AN-450 "Surface Mounting and their Effects on Product Reliability" for other methods of soldering surface mount devices.

Thermal Resistance

 $\begin{array}{lll} \theta_{JC} \mbox{ (MSOP)} & 55 \mbox{°C/W} \\ \theta_{JA} \mbox{ (MSOP)} & 210 \mbox{°C/W} \\ \theta_{JC} \mbox{ (SOP)} & 35 \mbox{°C/W} \\ \theta_{JA} \mbox{ (SOP)} & 170 \mbox{°C/W} \end{array}$

Operating Ratings

Temperature Range

$$\begin{split} T_{MIN} \leq T_{A} \leq T_{MAX} & -40\,^{\circ}\text{C} \leq T_{A} \leq 85\,^{\circ}\text{C} \\ \text{Supply Voltage} & 2.4\text{V} \leq \text{V}_{DD} \leq 5.5\text{V} \end{split}$$

Electrical Characteristics (Notes 1, 2)

The following specifications apply for $V_{DD} = 5V$ unless otherwise specified. Limits apply for $T_A = 25$ °C.

Symbol	Parameter	Conditions	LM4882		11.24
			Typical (Note 5)	Limit (Note 6)	Units (Limits)
I _{DD}	Quiescent Current	$V_{IN} = 0V$, $I_O = 0A$	2	4.0	mA (max)
I _{SD}	Shutdown Current	$V_{pin1} = V_{DD}$	0.5	5	μA (max)
V _{os}	Offset Voltage	V _{IN} = 0V	5	50	mV (max)
Po	Output Power	THD + N = 1% (max); f = 1 kHz;			
		$R_L = 4\Omega$	380		mW
		$R_L = 8\Omega$	270	250	mW (min)
		$R_L = 32\Omega$	95		mW
		THD + N = 10%; f = 1 kHz			
		$R_L = 4\Omega$	480		mW
		$R_L = 8\Omega$	325		mW
		$R_L = 32\Omega$	125		mW
THD + N	Total Harmonic Distortion + Noise	$R_L = 8\Omega$, $P_O = 250$ mWrms;	0.5		%
		$R_L = 32\Omega$, $P_O = 85$ mWrms;	0.1		%
		f = 1 kHz			
PSRR	Power Supply Rejection Ratio	$V_{pin3} = 2.5V, V_{ripple} = 200 \text{ mVrms},$ f = 120 Hz	50		dB

Electrical Characteristics (Notes 1, 2)

The following specifications apply for V_{DD} = 3V unless otherwise specified. Limits apply for T_A = 25°C.

Symbol	Parameter		LM4882		Units
		Conditions	Typical (Note 5)	Limit (Note 6)	(Limits)
I _{DD}	Quiescent Current	$V_{IN} = 0V, I_O = 0A$	1.2		mA
I _{SD}	Shutdown Current	$V_{pin1} = V_{DD}$	0.3		μΑ
V _{os}	Offset Voltage	V _{IN} = 0V	5		mV
Po	Output Power	THD + N = 1% (max); f = 1 kHz			
		$R_L = 8\Omega$	80		mW
		$R_L = 32\Omega$	30		mW
		THD + N = 10%; f = 1 kHz			
		$R_L = 8\Omega$	105		mW
		$R_L = 32\Omega$	40		mW

Electrical Characteristics (Notes 1, 2) (Continued)

The following specifications apply for $V_{DD} = 3V$ unless otherwise specified. Limits apply for $T_A = 25$ °C.

	Parameter	Conditions	LM4882		Units
Symbol			Typical (Note 5)	Limit (Note 6)	(Limits)
THD + N	Total Harmonic Distortion + Noise	$R_L = 8\Omega$, P $_O = 70$ mWrms;	0.25		%
		$R_L = 32\Omega$, $P_O = 30$ mWrms;	0.3		%
		f = 1 kHz			
PSRR	Power Supply Rejection Ratio	$V_{pin3} = 2.5V$, $V_{ripple} = 200 \text{ mVrms}$, $f = 120 \text{ Hz}$	50		dB

Note 1: All voltages are measured with respect to the ground pin, unless otherwise specified.

Note 2: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$. For the LM4882, $T_{JMAX} = 150^{\circ}\text{C}$, and the typical junction-to-ambient thermal resistance, when board mounted, is 210°C/W for the MUA08A Package and 170°C/W for the M08A Package.

Note 4: Human body model, 100 pF discharged through a 1.5 k Ω resistor.

Note 5: Typicals are measured at 25°C and represent the parametric norm.

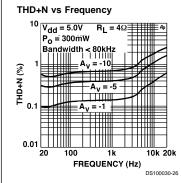
Note 6: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

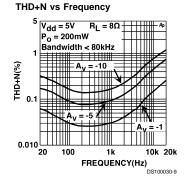
External Components Description

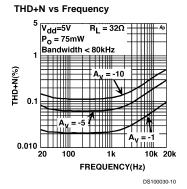
(Refer to Figure 1)

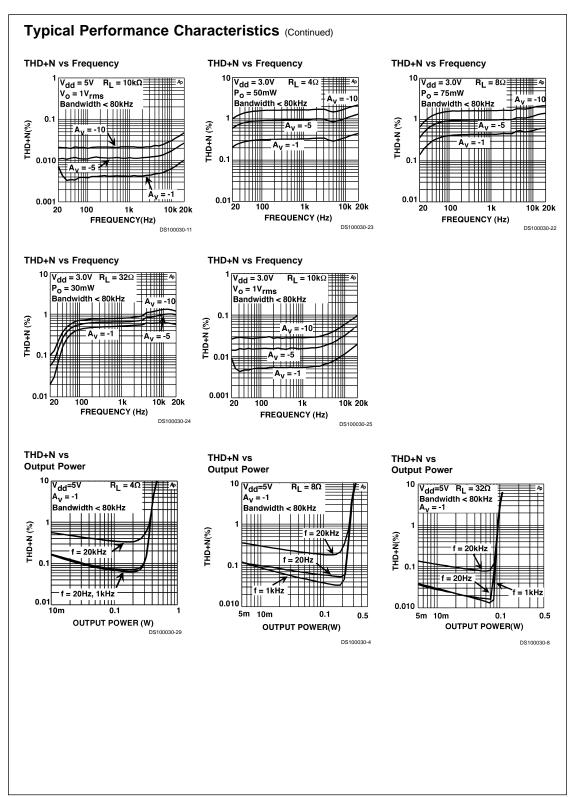
Components	Functional Description	
1. R _i	Inverting input resistance which sets the closed-loop gain in conjunction with R_f . This resistor also forms a high pass filter with C_i at $f_c = 1 / (2\pi R_i C_i)$.	
2. C _i	Input coupling capacitor which blocks the DC voltage at the amplifier's input terminals. Also creates a highpass filter with R_i at $f_c = 1$ / $(2\pi R_i C_i)$. Refer to the section, Proper Selection of External Components , for an explanation of how to determine the values of C_i .	
3. R _f	Feedback resistance which sets closed-loop gain in conjunction with R _i .	
4. C _S	Supply bypass capacitor which provides power supply filtering. Refer to the Application Information section for proper placement and selection of the supply bypass capacitor.	
5. C _B	Bypass pin capacitor which provides half-supply filtering. Refer to the section, Proper Selection of External Components , for information concerning proper placement and selection of C _B .	
6. C _O	Output coupling capacitor which blocks the DC voltage at the amplifier's output. Forms a high pass filter wth R_1 at $f_0 = 1 / (2\pi R_1 C_0)$.	

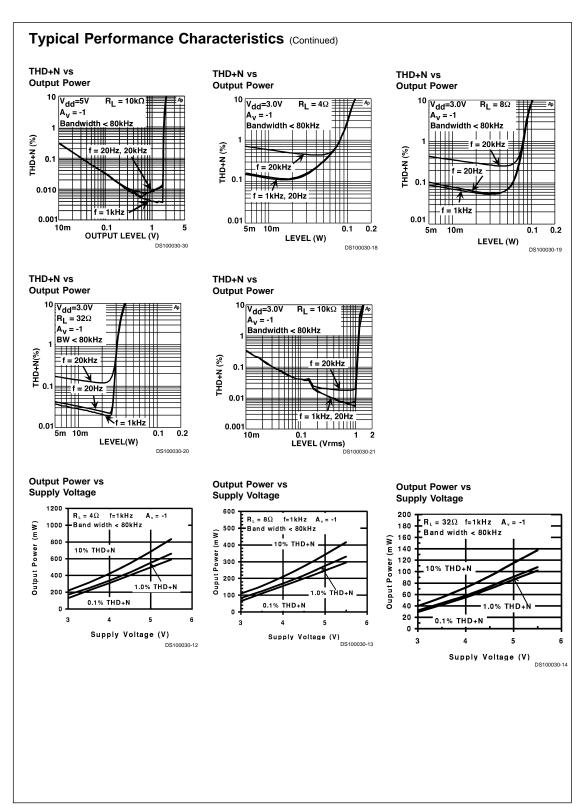
Typical Performance Characteristics





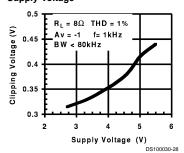




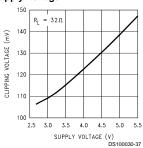


Typical Performance Characteristics (Continued)

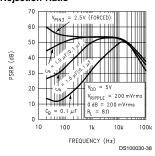
Dropout Voltage vs Supply Voltage



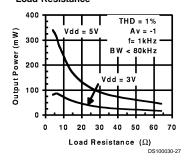
Dropout Voltage vs Supply Voltage



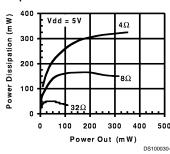
Power Supply Rejection Ratio



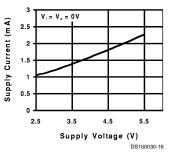
Output Power vs Load Resistance

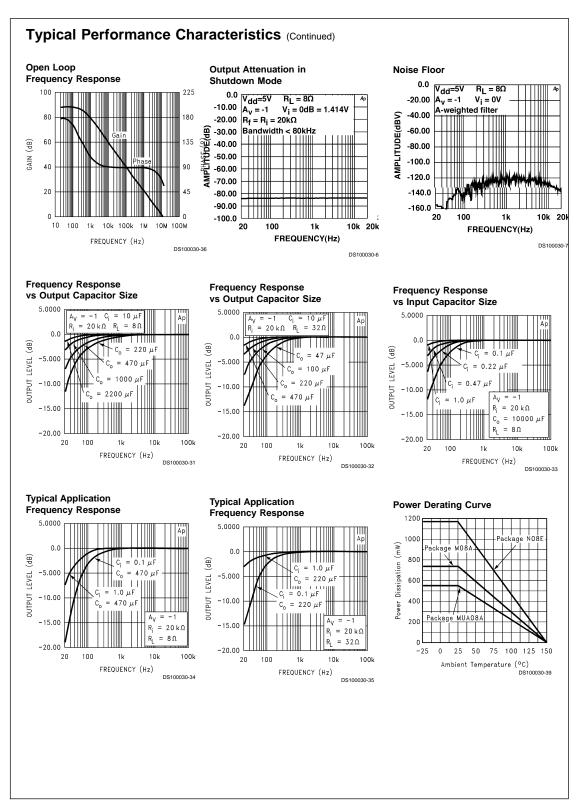


Power Dissipation vs Output Power



Supply Current vs Supply Voltage





Application Information

SHUTDOWN FUNCTION

In order to reduce power consumption while not in use, the LM4882 contains a shutdown pin to externally turn off the amplifier's bias circuitry. This shutdown features turns the amplifier off when a logic high is placed on the shutdown pin. The trigger point between a logic low and logic high level is typically half supply. It is best to switch between ground and supply to provide maximum device performance. By switching the shutdown pin to the $V_{\rm DD}$, the LM4882 supply current draw will be minimized in idle mode. While the device will be disabled with shutdown pin voltages less than V $_{\rm DD}$, the idle current may be greater than the typical value of 0.5 µA. In either case, the shutdown pin should be tied to a definite voltage because leaving the pin floating may result in an unwanted shutdown condition. In many applications, a microcontroller or microprocessor output is used to control the shutdown circuitry which provides a quick smooth transition into shutdown. Another solution is to use a single-pole, single-throw switch in conjunction with an external pull-up resistor. When the switch is closed, the shutdown pin is connected to ground and enables the amplifier. If the switch is open, then the external pull-up resistor will disable the LM4882. This scheme guarantees that the shutdown pin will not float which will prevent unwanted state changes.

POWER DISSIPATION

Power dissipation is a major concern when using any power amplifier and must be thoroughly understood to ensure a successful design. Equation 1 states the maximum power dissipation point for a single-ended amplifier operating at a given supply voltage and driving a specified output load.

$$P_{DMAX} = (V_{DD})^{2}/(2\pi^{2}R_{L})$$
 (1

Even with this internal power dissipation, the LM4882 does not require heat sinking over a large range of ambient temperature. From Equation 1, assuming a 5V power supply and an 4Ω load, the maximum power dissipation point is 316 mW. The maximum power dissipation point obtained must not be greater than the power dissipation that results from Equation 2:

$$P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA} \qquad (2)$$

For the LM4882 surface mount package, θ_{JA} = 210°C/W and T_{JMAX} = 150°C. Depending on the ambient temperature, T_A , of the system surroundings, Equation 2 can be used to find the maximum internal power dissipation supported by the IC packaging. If the result of Equation 1 is greater than that of Equation 2, then either the supply voltage must be decreased, the load impedance increased or T $_{\mbox{\scriptsize A}}$ reduced. For the typical application of a 5V power supply, with an 4Ω load, the maximum ambient temperature possible without violating the maximum junction temperature is approximately 83°C provided that device operation is around the maximum power dissipation point. Power dissipation is a function of output power and thus, if typical operation is not around the maximum power dissipation point, the ambient temperature may be increased accordingly. Refer to the Typical Performance Characteristics curves for power dissipation information for lower output powers.

POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. The capacitor location on both the bypass and power supply pins should be as close to the device as possible. As displayed in the **Typical Performance Characteristics** section, the effect of a larger half supply bypass capacitor is improved low frequency PSRR due to increased half-supply stability. Typical applications employ a 5V regulator with 10 μF and a 0.1 μF bypass capacitors which aid in supply stability, but do not eliminate the need for bypassing the supply nodes of the LM4882. The selection of bypass capacitors, especially C_{B} , is thus dependent upon desired low frequency PSRR, click and pop performance as explained in the section, **Proper Selection of External Components** section, system cost, and size constraints.

PROPER SELECTION OF EXTERNAL COMPONENTS

Selection of external components when using integrated power amplifiers is critical to optimize device and system performance. While the LM4882 is tolerant of external component combinations, consideration to component values must be used to maximize overall system quality.

The LM4882 is unity gain stable and this gives a designer maximum system flexibility. The LM4882 should be used in low gain configurations to minimize THD+N values, and maximize the signal to noise ratio. Low gain configurations require large input signals to obtain a given output power. Input signals equal to or greater than 1 Vrms are available from sources such as audio codecs. Please refer to the section, **Audio Power Amplifier Design**, for a more complete explanation of proper gain selection.

Besides gain, one of the major considerations is the closed loop bandwidth of the amplifier. To a large extent, the bandwidth is dictated by the choice of external components shown in Figure 1. Both the input coupling capacitor, C_i , and the output coupling capacitor, C_o , form first order high pass filters which limit low frequency response. These values should be chosen based on needed frequency response for a few distinct reasons.

CLICK AND POP CIRCUITRY

The LM4882 contains circuitry to minimize turn-on and turn-off transients or "clicks and pops." In this case, turn-on refers to either power supply turn-on or the device coming out of shutdown mode. When the device is turning on, the amplifiers are internally muted. An internal current source ramps up the voltage of the bypass pin. Both the inputs and outputs track the voltage at the bypass pin. The device will remain muted until the bypass pin has reached its half supply voltage, $1/2\ V_{\rm DD}$. As soon as the bypass node is stable, the device will become fully operational, where the gain is set by the external resistors.

Although the bypass pin current source cannot be modified, the size of $C_{\rm B}$ can be changed to alter the device turn-on time and the level of "clicks and pops." By increasing the value of C $_{\rm B}$, the level of turn-on pop can be reduced. However, the tradeoff for using a larger bypass capacitor is an increase in turn-on time for the device. There is a linear relationship between the size of $C_{\rm B}$ and the turn-on time. Here are some typical turn-on times for a given $C_{\rm B}$:

Св	T _{ON}
0.01 µF	20 ms
0.1 μF	200 ms
0.22 μF	420 ms
0.47 uF	900 ms

In order to eliminate "clicks and pops," all capacitors must be discharged before turn-on. Rapid on/off switching of the de-

Application Information (Continued)

vice or the shutdown function may cause the "click and pop" circuitry to not operate fully, resulting in increased "click and pop" noise.

The value of C_i will also reflect turn-on pops. Clearly, a certain size for C_i is needed to couple in low frequencies without excessive attenuation. But in many cases, the speakers used in portable systems have little ability to reproduce signals below 100 Hz to 150 Hz. In this case, using a large input and output coupling capacitor may not increase system performance. In most cases, choosing a small value of C_i in the range of 0.1 μF to 0.33 μF , along with C_B equal to 1.0 μF should produce a virtually clickless and popless turn-on. In cases where C_i is larger than 0.33 μF , it may be advantageous to increase the value of C_B . Again, it should be understood that increasing the value of C_B will reduce the "clicks and pops" at the expense of a longer device turn-on time.

AUDIO POWER AMPLIFIER DESIGN

Design a 250 mW/8Ω Audio Amplifier

Given:

Power Output 250 mWrms
Load Impedance 8Ω Input Level 1 Vrms (max)
Input Impedance 20 k Ω Bandwidth 100 Hz-20 kHz \pm 0.50 dB

A designer must first determine the needed supply rail to obtain the specified output power. Calculating the required supply rail involves knowing two parameters, $V_{\rm OPEAK}$ and also the dropout voltage. The latter is typically 530mV and can be found from the graphs in the $\mbox{Typical Performance Characteristics.}\ V_{\rm OPEAK}$ can be determined from Equation 3.

$$V_{\text{opeak}} = \sqrt{(2R_{L}P_{0})}$$

For 250 mW of output power into an 8Ω load, the required V_{OPEAK} is 2 volts. A minimum supply rail of 4.55V results from adding V_{OPEAK} and V_{OD}. Since 5V is a standard supply voltage in most applications, it is chosen for the supply rail.

Extra supply voltage creates headroom that allows the LM4882 to reproduce peaks in excess of 300 mW without clipping the signal. At this time, the designer must make sure that the power supply choice along with the output impedance does not violate the conditions explained in the **Power Dissipation** section.

Once the power dissipation equations have been addressed, the required gain can be determined from Equation 4.

$$A_{V} \ge \sqrt{(P_{0}R_{L})}/(V_{1N}) = V_{orms}/V_{inrms}$$

$$A_{V} = R_{f}/R_{i}$$
 (5)

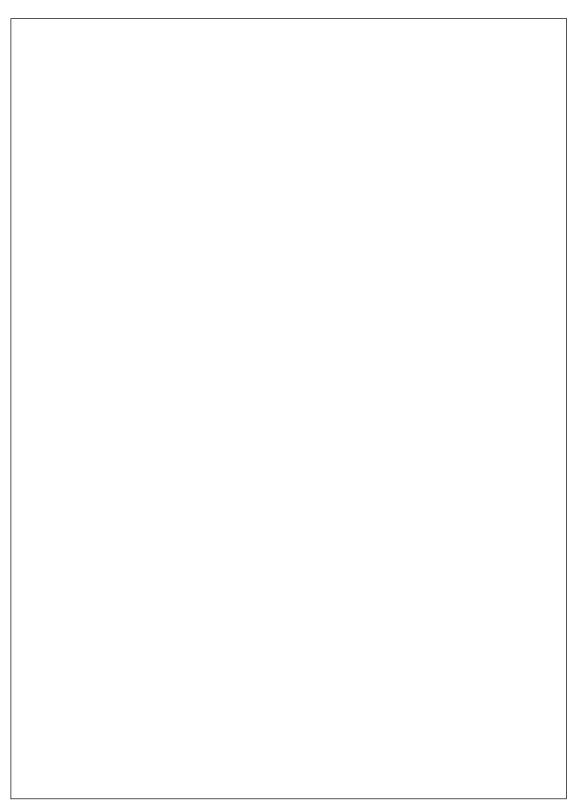
From Equation 4, the minimum gain is:

$$A_{V} = 1.4$$

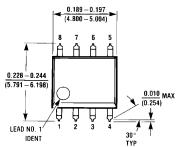
Since the desired input impedance was 20 $k\Omega,$ and with a gain of 1.4, a value of 28 k Ω is designated for R_f, assuming 5% tolerance resistors. This combination results in a nominal gain of 1.4. The final design step is to address the bandwidth requirements which must be stated as a pair of -3 dB frequency points. Five times away from a -3 dB point is 0.17 dB down from passband response assuming a single pole rolloff. As stated in the External Components section, both R. in conjunction with C i, and Co with RL, create first order highpass filters. Thus to obtain the desired frequency low response of 100 Hz within ±0.5 dB, both poles must be taken into consideration. The combination of two single order filters at the same frequency forms a second order response. This results in a signal which is down 0.34 dB at five times away from the single order filter -3 dB point. Thus, a frequency of 20 Hz is used in the following equations to ensure that the response is better than 0.5 dB down at 100 Hz.

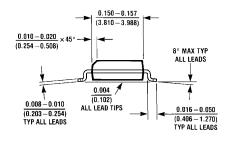
$$C_i \ge 1 / (2\pi * 20 \text{ k}\Omega * 20 \text{ Hz}) = 0.397 \text{ μF}; \text{ use } 0.39 \text{ μF}.$$
 $C_0 \ge 1 / (2\pi * 8\Omega * 20 \text{ Hz}) = 995 \text{ μF}; \text{ use } 1000 \text{ μF}.$

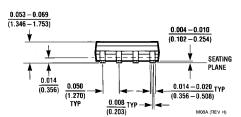
The high frequency pole is determined by the product of the desired high frequency pole, $f_{\rm H},$ and the closed-loop gain, A $_{\rm V}$. With a closed-loop gain of 1.4 and $f_{\rm H}$ = 100 kHz, the resulting GBWP = 140 kHz which is much smaller than the LM4882 GBWP of 12.5Mhz. This figure displays that if a designer has a need to design an amplifier with a higher gain, the LM4882 can still be used without running into bandwidth limitations.



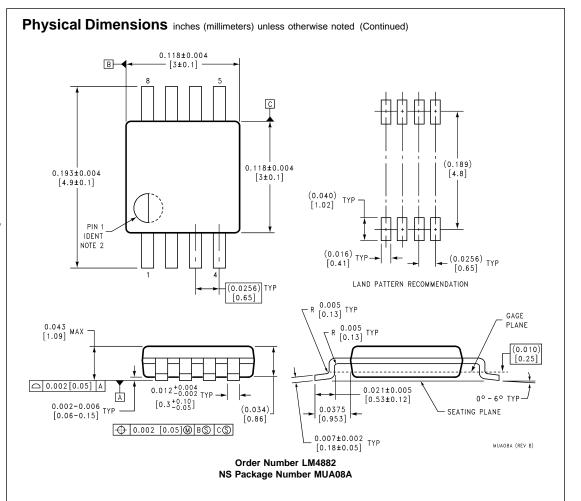








Order Number LM4882 NS Package Number M08A



LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMI-CONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation Americas

Tel: 1-800-272-9959 Fax: 1-800-737-7018 Email: support@nsc.com

www.national.com

National Semiconductor Europe

Fax: +49 (0) 1 80-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 1 80-530 85 85
English Tel: +49 (0) 1 80-532 78 32
Français Tel: +49 (0) 1 80-532 93 88
Italiano Tel: +49 (0) 1 80-534 16 80

National Semiconductor Asia Pacific Customer Response Group Tel: 65-2544466 Fax: 65-2504466 Email: sea.support@nsc.com National Semiconductor Japan Ltd. Tel: 81-3-5620-6175 Fax: 81-3-5620-6179

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications